SILICON (Si) POWER MOSFET A CEZ10R10A

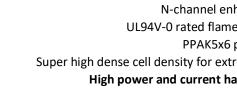


CEZ10R10A

100V A 8mΩ A 64A A Si MOSFET

SILICON SI MOSFET A SMD type N-channel enhancement mode UL94V-0 rated flame retardant epoxy PPAK5x6 package ▲ MSL 3 Super high dense cell density for extremely low R_{DS(ON)} High power and current handling capability

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MAXIMUM RATINGS

Parameter (T _A = 25°C, unless otherwise noted)		Characteristics
Drain-Source Voltage	V _{DS}	100V
Gate-Source Voltage	V _{GS}	±20V
Continuous Drain Current at R _{TH_JC}	I _D	64A
Continuous Drain Current at R _{TH_JA}	I _D	19A
Pulsed Drain Current Note 1	I _{DM}	256A
Pulsed Drain Current Note 1	I _{DM}	76A
Maximum Power Dissipation	PD	71W
Single Pulsed Avalanche Energy Note 5	E _{AS}	56mJ
Single Pulsed Avalanche Current Note 5	I _{AS}	15A
Operating and Storage Temperature Range	Т _J , Т _{STG}	-55°C to +150°C

RoHS

REACH

HALOGEN

FREE

THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R _{TH_JC}	1.75°C/W
Thermal Resistance, Junction-to-Ambient Note 2	R _{TH_JA}	20°C/W

APPLICATIONS

Battery Management Systems	E-Bike	Industrial Control	Power Inverter	UPS
+ 4 -	50			

PIN DESCRIPTION

Circuit Diagram	Outline - Bottom View	Pin No.	Description
G (4) S (1,2,3)		1 2 3 4 5	Source Source Gate Drain

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ELECTRICAL CHARACTERISTICS A T_A = 25°C, unless otherwise noted

ltem	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 250\mu A$	BV _{DSS}	100			V
Zero Gate Voltage Drain Current	$V_{DS} = 80V, V_{GS} = 0V$	I _{DSS}			1	μA
Gate Body Leakage Current, Forward	$V_{GS} = 20V, V_{DS} = 0V$	I _{GSSF}			100	nA
Gate Body Leakage Current, Reverse	V_{GS} = -20V, V_{DS} = 0V	I _{GSSR}			-100	nA
On Characteristics Note 3						
Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \mu A$	$V_{GS(th)}$	2		4	V
Static Drain-Source On-Resistance	$V_{GS} = 10V, I_{D} = 20A$	R _{DS(ON)}		8	9.6	mΩ
Static Drain-Source On-Resistance	$V_{GS} = 6V, I_{D} = 10A$	R _{DS(ON)}		12	15.5	mΩ
Dynamic Characteristics Note 4						
Input Capacitance	V_{DS} = 50V, V_{GS} = 0V, f = 1MHz	C _{ISS}		1395		рF
Output Capacitance	$V_{DS} = 50V, V_{GS} = 0V, f = 1MHz$	Coss		541		рF
Reverse Transfer Capacitance	V_{DS} = 50V, V_{GS} = 0V, f = 1MHz	C _{RSS}		5		рF
Switching Characteristics Note 4						
Turn-On Delay Time	V_{DD} = 30V, V_{GS} = 10V, I_{D} = 1A, $R_{\text{G}(\text{ext})}$ = 6 Ω	t _{D(ON)}		29		ns
Turn-On Rise Time	V_{DD} = 30V, V_{GS} = 10V, I_{D} = 1A, $R_{G(ext)}$ = 6Ω	t _R		7		ns
Turn-Off Delay Time	V_{DD} = 30V, V_{GS} = 10V, I_{D} = 1A, $R_{\text{G}(\text{ext})}$ = 6 Ω	t _{D(OFF)}		48		ns
Turn-Off Fall Time	V_{DD} = 30V, V_{GS} = 10V, I_{D} = 1A, $R_{G(ext)}$ = 6Ω	t _F		23		ns
Total Gate Charge	$V_{DS} = 50V, V_{GS} = 6V, I_D = 10A$	Q_{G}		19		nC
Gate Source Charge	$V_{DS} = 50V, V_{GS} = 6V, I_D = 10A$	Q _{GS}		6		nC
Gate Drain Charge	V_{DS} = 50V, V_{GS} = 6V, I_{D} = 10A	\mathbf{Q}_{GD}		11		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					
Drain-Source Diode Forward Current ^{Note3}		١ _s			64	A
Drain-Source Diode Forward Voltage ^{Note3}	V _{GS} = 0V, I _S = 10A	V_{SD}			1.1	V

Notes

1: Repetitive Rating: Pulse width limited by maximum junction temperature

2: Surface Mounted on FR4 Board, $t \le 10$ sec

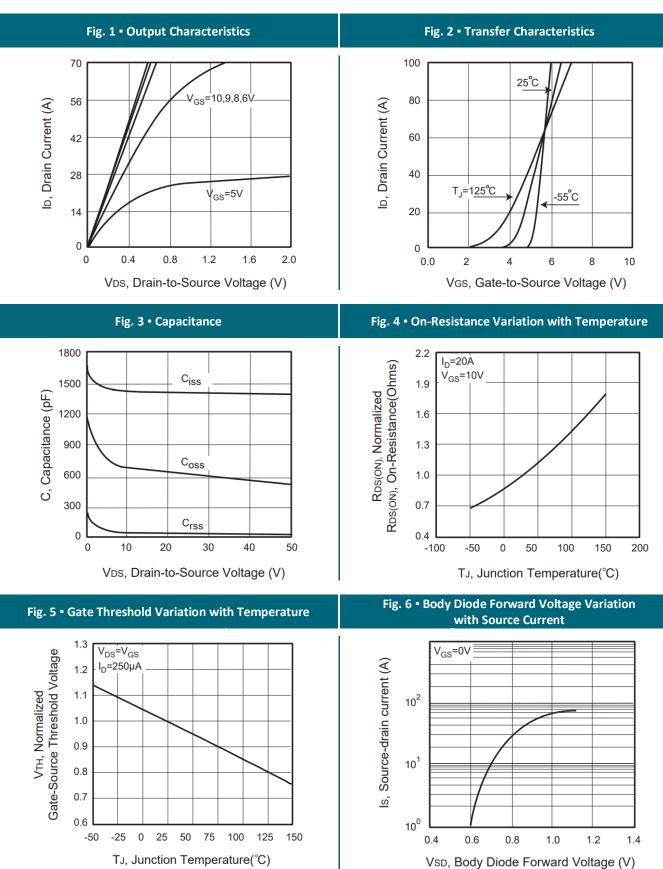
3: Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4: Guaranteed by design, not subject to production testing.

5: L = 0.5mH, $I_{AS} = 15A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}C$



REFERENCE DATA A TYPICAL DEVICE PERFORMANCE





REFERENCE DATA A TYPICAL DEVICE PERFORMANCE

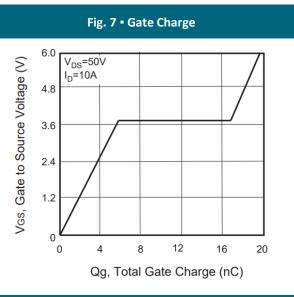


Fig. 9 - Breakdown Voltage Variation vs. Temperature

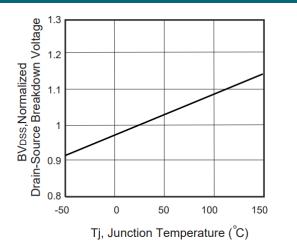
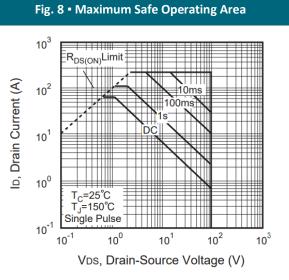
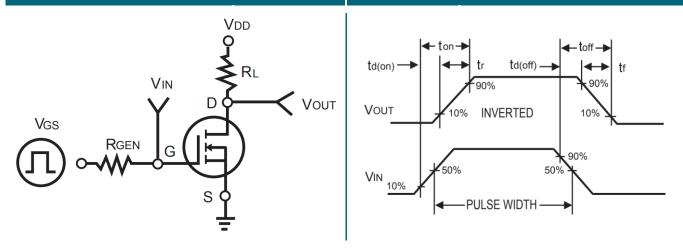


Fig. 10 - Switching Test Circuit





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REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE

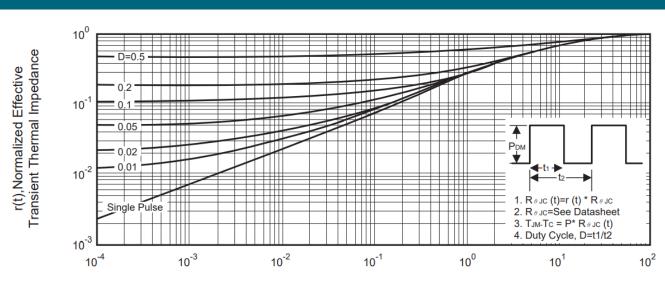
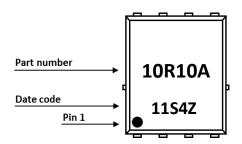


Fig. 12 • Normalized Thermal Transient Impedance Curve

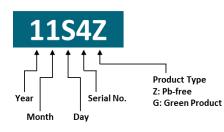
Square Wave Pulse Duration (sec)

PART MARKING



DATE CODE

Example: 11S4Z



Coding list for "Day"										
1	2	3	4	5	6	7	8	9	Α	
01	02	03	04	05	06	07	08	09	10	
В	С	D	Ε	F	G	Н	I	J	K	
11	12	13	14	15	16	17	18	19	20	
L	Μ	Ν	0	Ρ	Q	R	S	Т	U	
21	22	23	24	25	26	27	28	29	30	
v										
31										

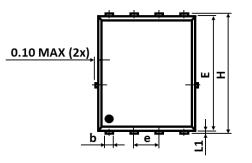
Coding list for "Month"

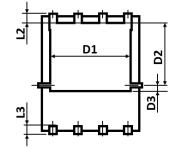


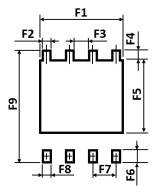
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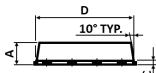


PACKAGE OUTLINE AND RECOMMENDED PAD LAYOUT









Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	0.800	-	1.170	E	5.650	-	5.900
b	0.340	-	0.490	е		1.270 TYP	
С	0.200	-	0.340	Н	5.900	-	6.150
D	4.800	-	5.100	L1	0.050	-	0.250
D1	3.800	-	4.200	L2	0.380	-	0.620
D2	3.180	-	3.780	L3	0.380	-	0.750
D3	0.150	-	0.360				

Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)	Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
F1	-	4.500	-	F6	-	0.800	-
F2	-	0.500	-	F7	-	1.270	-
F3	-	0.770	-	F8	-	0.500	-
F4	-	0.550	-	F9	-	6.250	-
F5	-	3.650	-				

Notes: 1. The suggested land pattern dimensions have been provided for reference only. 2. For further information, please reference document IPC-7351A.

ORDERING INFORMATION

Part Number	Package	Packing	Reel Qty.	Inner Box Qty.	Outer Box Qty.	
CEZ10R10A	PPAK 5x6	Reel	2,500pcs	5,000pcs	40,000pcs	

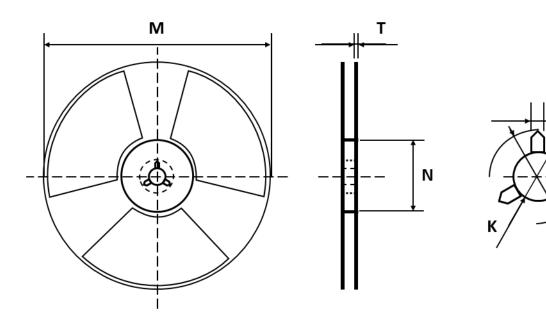


S

Н

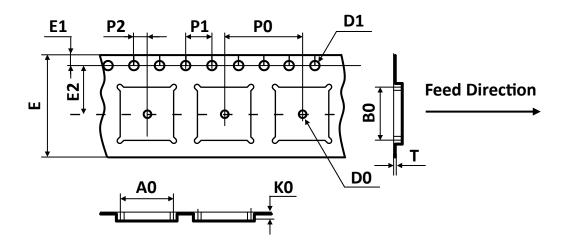


REEL DIMENSIONS All dimensions in mm



Tape Size	Reel Size	М	N	т	Н	К	S
		Ø330.00	Ø100.00	2.10	22.00	13.00	2.00
12mm	Ø330	±2.00	±1.00	±0.20	±0.50	+0.50 -0.20	±0.50

TAPE DIMENSIONS All dimensions in mm



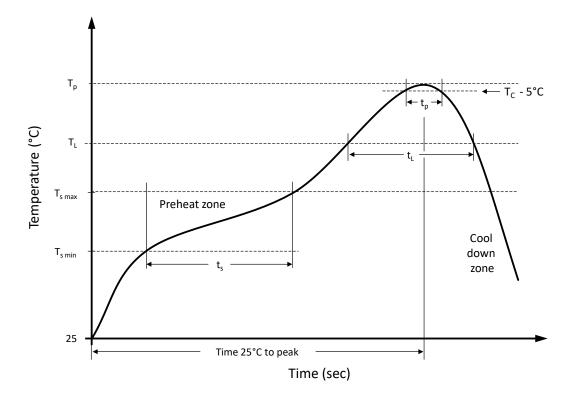
Package	A0	B0	К0	D0	D1	E	E1	E2	P0	P1	P2	т
	6.50	5.28	2.00	1.50	1.50	12.00	1.75	5.50	8.00	4.00	2.00	0.25
PPAK 5x6	±0.10	±0.10	±0.10	±0.25	±0.10	+0.30 -0.10	±0.10	±0.05	±0.10	±0.10	±0.05	±0.02







RECOMMENDED REFLOW SOLDERING PROFILE



Recommended reflow soldering conditions ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	T_{smin}	100 °C	150 °C
Preheat temperature max.	$T_{s max}$	150 °C	200 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	120 seconds	120 seconds
Ramp-up rate (T _L to T _p)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	TL	183 °C	217 °C
Time t_L maintained above T_L	t∟	150 seconds max.	150 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	tp	20 seconds max.	30 seconds max.
Ramp-down rate (T_L to T_p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes



REVISION TABLE

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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